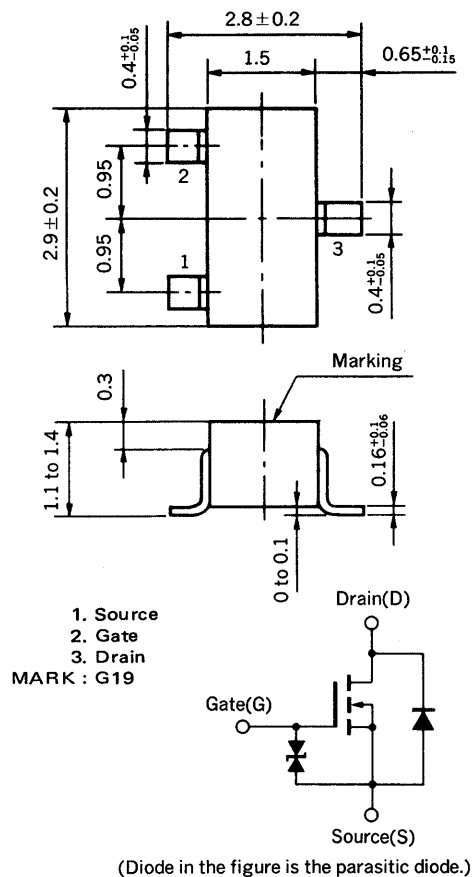


MOS FIELD EFFECT TRANSISTOR

2SK1657

N-CHANNEL MOS FET FOR SWITCHING

PACKAGE DIMENSIONS (Unit: mm)



The 2SK1657 is an N-channel vertical type MOS FET which can be driven by 2.5 V power supply.

As the MOS FET is low Gate Leakage Current, it is suitable for filter circuit.

FEATURES

- Directly driven by ICs having a 3 V power supply.
- Has low Gate Leakage Current
 $I_{GSS} = \pm 5 \text{ nA MAX. @ } V_{GS} = \pm 3.0 \text{ V}$

QUALITY GRADE

Standard

Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

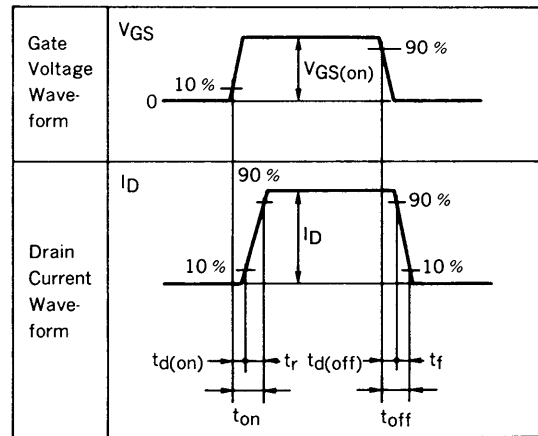
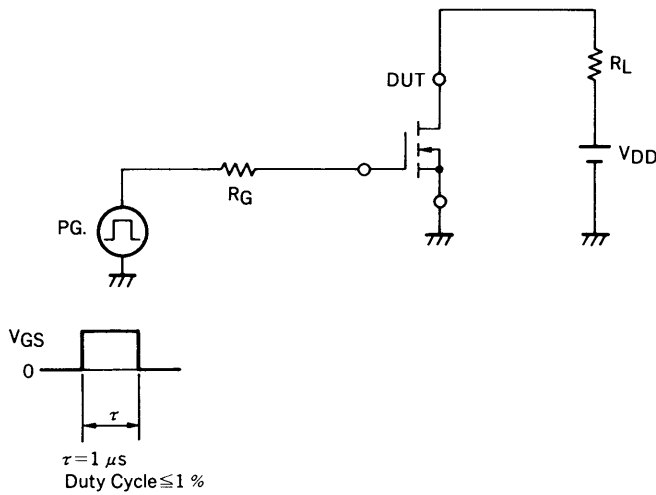
ABSOLUTE MAXIMUM RATINGS ($T_a = 25^\circ\text{C}$)

PARAMETER	SYMBOL	RATINGS	UNIT	TEST CONDITIONS
Drain to Source Voltage	V_{DSS}	30	V	$V_{GS} = 0$
Gate to Source Voltage	V_{GSS}	± 7	V	$V_{DS} = 0$
Drain Current	$I_D(\text{DC})$	± 100	mA	
Drain Current	$I_D(\text{pulse})$	± 200	mA	$PW \leq 10 \text{ ms}, \text{Duty Cycle} \leq 50 \%$
Total Power Dissipation	P_T	200	mW	
Channel Temperature	T_{ch}	150	$^\circ\text{C}$	
Operating Temperature	T_{opt}	$-55 \text{ to } +80$	$^\circ\text{C}$	
Storage Temperature	T_{stg}	$-55 \text{ to } +150$	$^\circ\text{C}$	

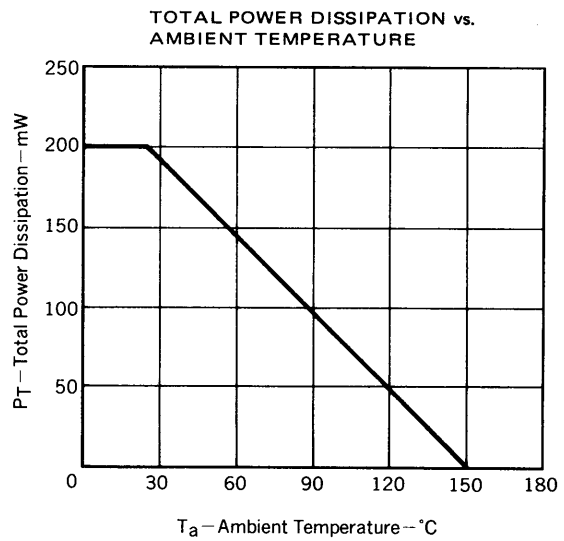
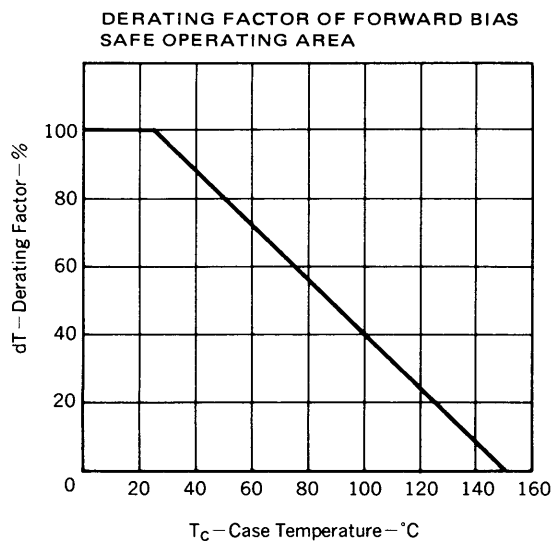
ELECTRICAL CHARACTERISTICS (T_a = 25 °C)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain Cut-off Current	I _{DSS}			10	μA	V _{DS} = 30 V, V _{GS} = 0
Gate Leakage Current	I _{GSS}			±5.0	nA	V _{GS} = ±3.0 V, V _{DS} = 0
Gate Cut-off Voltage	V _{GS(off)}	0.9	1.2	1.5	V	V _{DS} = 3.0 V, I _D = 1.0 μA
Forward Transfer Admittance	Y _{fs}	20	40		mS	V _{DS} = 3.0 V, I _D = 10 mA
Drain to Source On-State Resistance	R _{DS(on)1}		25	45	Ω	V _{GS} = 2.5 V, I _D = 10 mA
Drain to Source On-State Resistance	R _{DS(on)2}		18	25	Ω	V _{GS} = 4.0 V, I _D = 10 mA
Input Capacitance	C _{iss}		15		pF	V _{DS} = 3.0 V, V _{GS} = 0, f = 1 MHz
Output Capacitance	C _{oss}		10		pF	
Feedback Capacitance	C _{rss}		1.5		pF	
Turn-On Delay Time	t _{d(on)}		95		ns	V _{DD} = 3.0 V, I _D = 10 mA V _{GS(on)} = 3 V, R _G = 10 Ω R _L = 300 Ω
Rise Time	t _r		360		ns	
Turn-Off Delay Time	t _{d(off)}		160		ns	
Fall Time	t _f		150		ns	

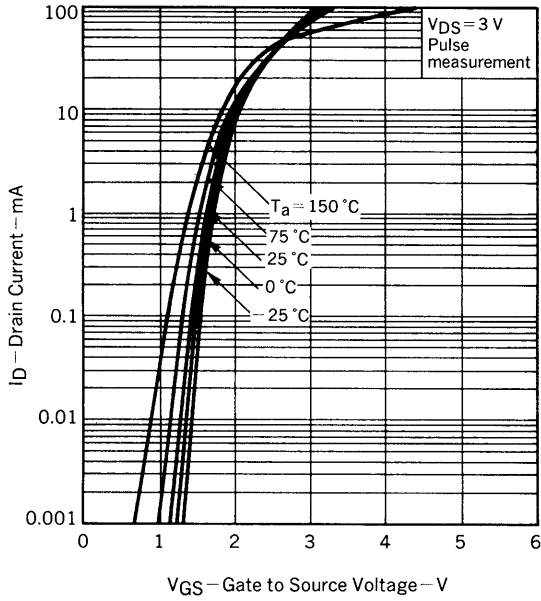
SWITCHING TIME MEASUREMENT CIRCUIT AND CONDITIONS



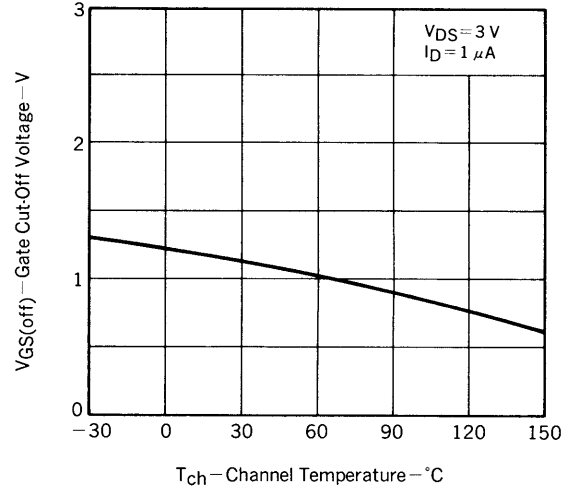
TYPICAL CHARACTERISTICS (T_a = 25 °C)



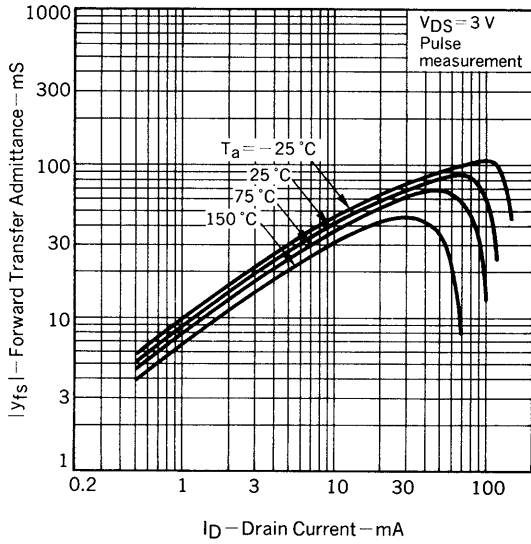
TRANSFER CHARACTERISTICS



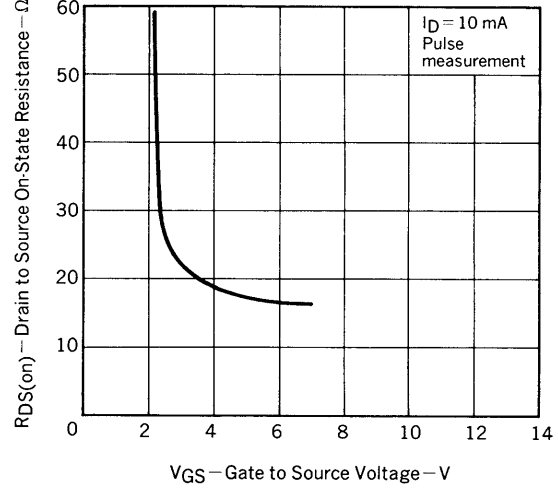
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE



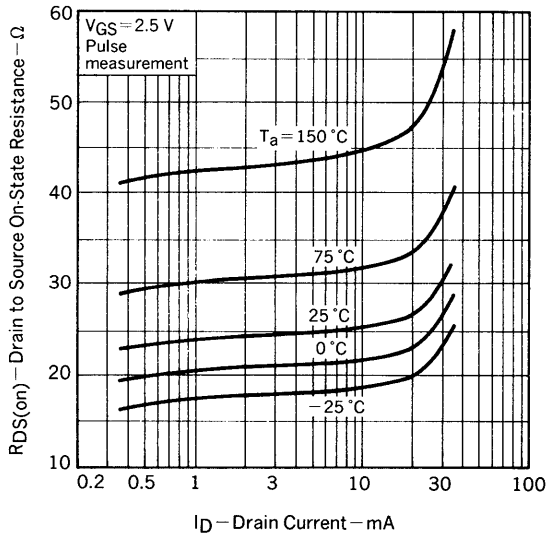
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



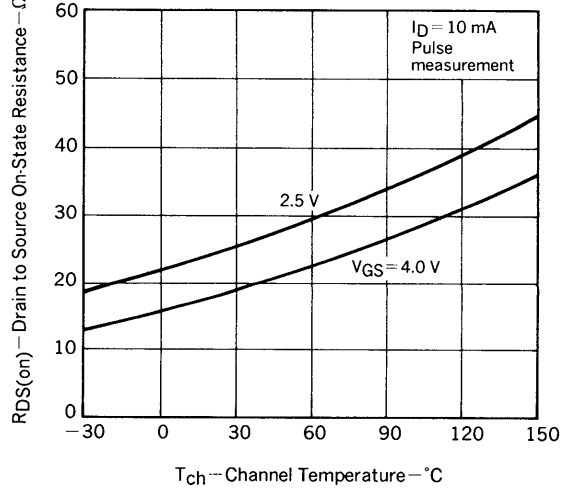
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



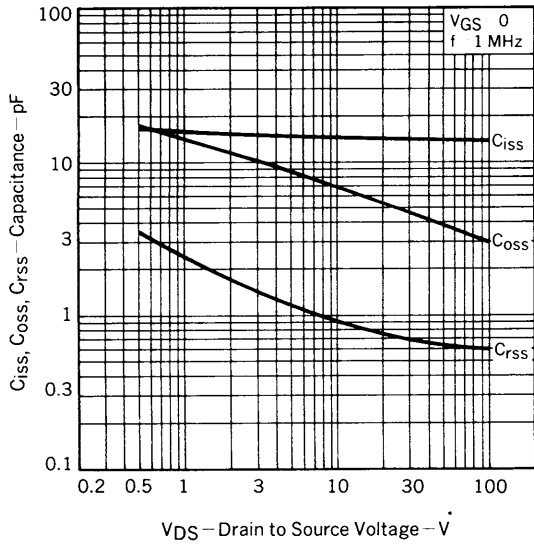
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



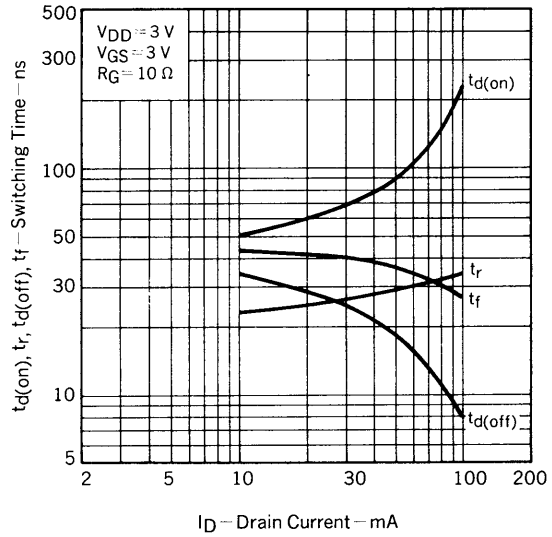
DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



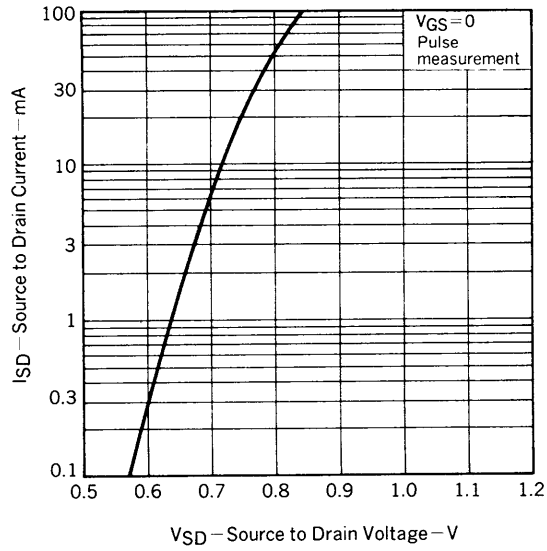
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



SWITCHING CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE



RECOMMENDED SOLDERING CONDITIONS

Mounting of this product by soldering should be done under the following conditions.
 Please consult our representatives about soldering methods and conditions other than these.

SURFACE MOUNT TYPE

For details of the recommended soldering conditions, see the information document "SMT MANUAL" (IEI-1207).

Soldering Method	Soldering Conditions	Symbol for Recommended Conditions
Infrared Reflow	Package peak temp.: 230 °C Soldering time: within 30 sec (above 210 °C) Soldering times: 1, Days limitation: none*	IR30-00
Vapor Phase Soldering	Package peak temp.: 215 °C Soldering time: within 40 sec (above 200 °C) Soldering times: 1, Days limitation: none*	VP15-00
Wave Soldering	Soldering bath temp.: below 260 °C Soldering time: within 10 sec Soldering times: 1, Days limitation: none*	WS60-00

*: Stored days under storage conditions at 25 °C and below 65 % R.H. after the dry-pack has been opened.

Note 1 Combination of soldering methods should be avoided.

[MEMO]

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Application examples recomended by NEC Corporation

Standard: Data processing and office equipment, Communication equipment (terminal, mobile). Test and Measurement equipment, Audio and Video equipment, Other consumer products, etc.

Special: Automotive and Transportation equipment, Communication equipment (trunk line), Train and Traffic control devices, industrial robots, Burning control systems, antidisaster systems, anticrime systems etc.



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